# 74HC373; 74HCT373

# Octal D-type transparent latch; 3-state Rev. 6 — 26 February 2016

**Product data sheet** 

#### 1. **General description**

The 74HC373; 74HCT373 is an octal D-type transparent latch with 3-state outputs. The device features latch enable (LE) and output enable (OE) inputs. When LE is HIGH, data at the inputs enter the latches. In this condition the latches are transparent, a latch output will change each time its corresponding D-input changes. When LE is LOW the latches store the information that was present at the inputs a set-up time preceding the HIGH-to-LOW transition of LE. A HIGH on OE causes the outputs to assume a high-impedance OFF-state. Operation of the OE input does not affect the state of the latches. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V<sub>CC</sub>.

#### 2. **Features and benefits**

- Input levels:
  - ◆ For 74HC373: CMOS level
  - ◆ For 74HCT373: TTL level
- 3-state non-inverting outputs for bus oriented applications
- Common 3-state output enable input
- Functionally identical to the 74HC563; 74HCT563 and 74HC573; 74HCT573
- Complies with JEDEC standard no. 7 A
- ESD protection:
  - ♦ HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

#### **Ordering information** 3.

Table 1. **Ordering information** 

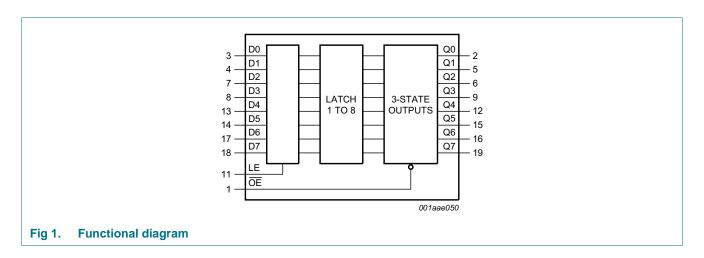
Type number	Package			
	Temperature range	Name	Description	Version
74HC373D	−40 °C to +125 °C	SO20	plastic small outline package; 20 leads;	SOT163-1
74HCT373D	-		body width 7.5 mm	
74HC373DB	–40 °C to +125 °C	SSOP20	plastic shrink small outline package; 20 leads;	SOT339-1
74HCT373DB	1		body width 5.3 mm	

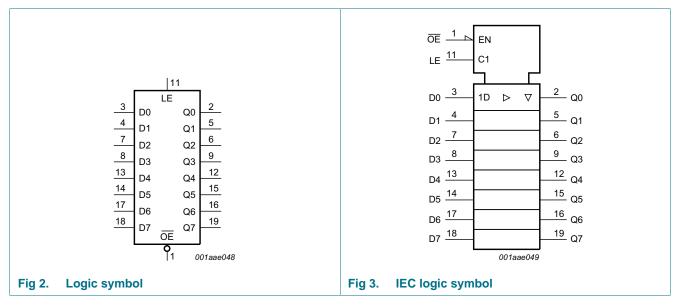


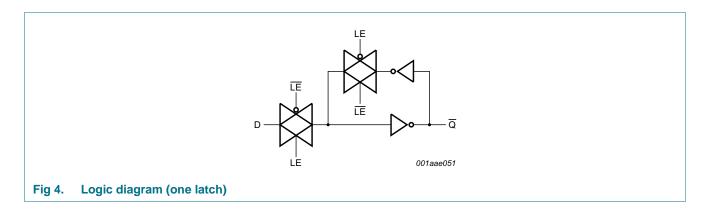
 Table 1.
 Ordering information ...continued

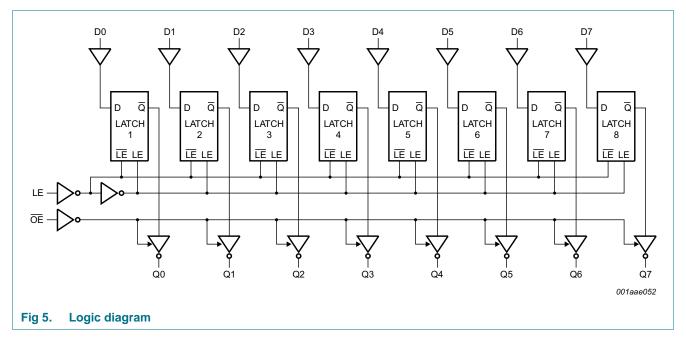
Type number	Package						
	Temperature range	Name	Description	Version			
74HC373PW			plastic thin shrink small outline package; 20 leads;	SOT360-1			
74HCT373PW			body width 4.4 mm				
74HC373BQ	−40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very	SOT764-1			
74HCT373BQ			thin quad flat package; no leads; 20 terminals; body $2.5 \times 4.5 \times 0.85$ mm				

# 4. Functional diagram



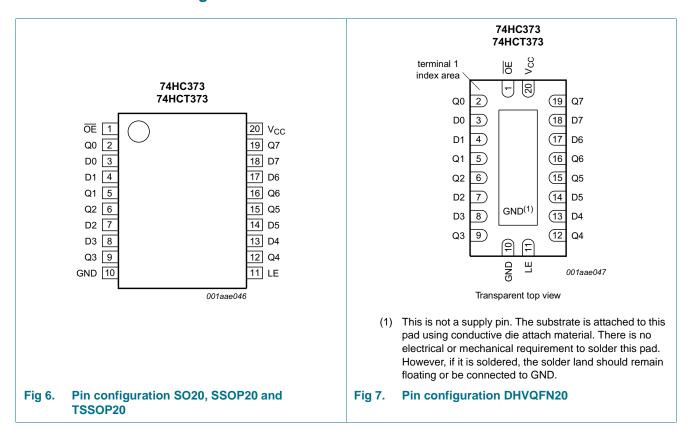






# 5. Pinning information

## 5.1 Pinning



# 5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
ŌĒ	1	3-state output enable input (active LOW)
Q0, Q1, Q2, Q3, Q4, Q5, Q6, Q7	2, 5, 6, 9, 12, 15, 16, 19	3-state latch output
D0, D1, D2, D3, D4, D5, D6, D7	3, 4, 7, 8, 13, 14, 17, 18	data input
GND	10	ground (0 V)
LE	11	latch enable input (active HIGH)
Vcc	20	supply voltage

# 6. Functional description

### 6.1 Function table

Table 3. Function table[1]

Operating mode	Control		Input	Internal latches	Output
	OE	LE	Dn		Qn
Enable and read register	L	Н	L	L	L
(transparent mode)			Н	Н	Н
Latch and read register	L	L	I	L	L
			h	Н	Н
Latch register and disable outputs	Н	Х	Х	X	Z

<sup>[1]</sup> H = HIGH voltage level;

h = HIGH voltage level one set-up time prior to the HIGH-to-LOW LE transition;

L = LOW voltage level;

I = LOW voltage level one set-up time prior to the HIGH-to-LOW LE transition;

X = don't care;

Z = high-impedance OFF-state.

# 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage			-0.5	+7	V
I <sub>IK</sub>	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{CC} + 0.5 \text{ V}$		-	±20	mA
I <sub>OK</sub>	output clamping current	$V_O < -0.5 \text{ V or } V_O > V_{CC} + 0.5 \text{ V}$		-	±20	mA
Io	output current	$V_{O} = -0.5 \text{ V to } (V_{CC} + 0.5 \text{ V})$		-	±35	mA
I <sub>CC</sub>	supply current			-	+70	mA
I <sub>GND</sub>	ground current			-	-70	mA
T <sub>stg</sub>	storage temperature			<del>-</del> 65	+150	°C
P <sub>tot</sub>	total power dissipation	SO20 package	<u>[1]</u>	-	500	mW
		SSOP20 package	[2]	-	500	mW
		TSSOP20 package	[2]	-	500	mW
		DHVQFN20 package	[3]	-	500	mW

<sup>[1]</sup> For SO20: Ptot derates linearly with 8 mW/K above 70 °C.

<sup>[2]</sup> For SSOP20 and TSSOP20 packages: Ptot derates linearly with 5.5 mW/K above 60 °C.

<sup>[3]</sup> For DHVQFN20 package: Ptot derates linearly with 4.5 mW/K above 60 °C.

# 8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	itions 74HC373			74HCT373			Unit
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	+25	+125	-40	+25	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>CC</sub> = 2.0 V	-	-	625	-	-	-	ns/V
		V <sub>CC</sub> = 4.5 V	-	1.67	139	-	1.67	139	ns/V
		V <sub>CC</sub> = 6.0 V	-	-	83	-	-	-	ns/V

# 9. Static characteristics

### Table 6. Static characteristics 74HC373

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub> = 25	°C		'			
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 2.0 V	1.5	1.2	-	V
		V <sub>CC</sub> = 4.5 V	3.15	2.4	-	V
		V <sub>CC</sub> = 6.0 V	4.2	3.2	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 2.0 V	-	0.8	0.5	V
		V <sub>CC</sub> = 4.5 V	-	2.1	1.35	V
		V <sub>CC</sub> = 6.0 V	-	2.8	1.8	V
V <sub>OH</sub>	HIGH-level output voltage	$V_{I} = V_{IH}$ or $V_{IL}$	-	-	-	
		$I_{O} = -20 \mu A; V_{CC} = 2.0 V$	1.9	2.0	-	V
		$I_{O} = -20 \mu A; V_{CC} = 4.5 V$	4.4	4.5	-	V
		$I_{O} = -20 \mu A; V_{CC} = 6.0 V$	5.9	6.0	-	V
		$I_{O} = -6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	4.32	-	V
		$I_{O} = -7.8 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.48	5.81	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_{I} = V_{IH}$ or $V_{IL}$				
		$I_O = 20 \mu A; V_{CC} = 2.0 \text{ V}$	-	0	0.1	V
		$I_O = 20 \mu A; V_{CC} = 4.5 V$	-	0	0.1	V
		$I_O = 20 \mu A; V_{CC} = 6.0 \text{ V}$	-	0	0.1	V
		$I_O = 6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.15	0.26	V
		$I_O = 7.8 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	V
l <sub>l</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	μΑ
loz	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 6.0$ V; $V_O = V_{CC}$ or GND	-	-	±0.5	μА
I <sub>CC</sub>	supply current	$V_{CC} = 6.0 \text{ V}; I_O = 0 \text{ A};$ $V_I = V_{CC} \text{ or GND}$	-	-	8.0	μΑ
Cı	input capacitance		-	3.5	-	pF

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 Table 6.
 Static characteristics 74HC373 ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub> = -4	0 °C to +85 °C		,			
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 2.0 V	1.5	-	-	V
		V <sub>CC</sub> = 4.5 V	3.15	-	-	V
		V <sub>CC</sub> = 6.0 V	4.2	-	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 2.0 V	-	-	0.5	V
		V <sub>CC</sub> = 4.5 V	-	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	-	1.8	V
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_{O} = -20 \mu A; V_{CC} = 2.0 V$	1.9	-	-	V
		$I_{O} = -20 \mu A; V_{CC} = 4.5 V$	4.4	-	-	V
		$I_{O} = -20 \mu A; V_{CC} = 6.0 V$	5.9	-	-	V
		$I_{O} = -6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.84	-	-	V
		$I_O = -7.8 \text{ mA}; V_{CC} = 6.0 \text{ V}$ 5.34	V			
V <sub>OL</sub>	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_O = 20 \mu A; V_{CC} = 2.0 V$	-	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 4.5 V$	-	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 6.0 \text{ V}$	-	-	0.1	V
		$I_{O} = 6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.33	V
		$I_O = 7.8 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	-	0.33	V
l <sub>l</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±1.0	μΑ
loz	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 6.0$ V; $V_O = V_{CC}$ or GND	-	-	±5.0	μА
lcc	supply current	$V_{CC} = 6.0 \text{ V}; I_{O} = 0 \text{ A};$ $V_{I} = V_{CC} \text{ or GND}$	-	-	80	μΑ
Γ <sub>amb</sub> = -4	0 °C to +125 °C				1	
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 2.0 V	1.5	-	-	V
		V <sub>CC</sub> = 4.5 V	3.15	-	-	V
		V <sub>CC</sub> = 6.0 V	4.2	-	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 2.0 V	-	-	0.5	V
		V <sub>CC</sub> = 4.5 V	-	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	-	1.8	V
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_{O} = -20 \mu A; V_{CC} = 2.0 V$	1.9	-	-	V
		$I_{O} = -20 \mu A; V_{CC} = 4.5 V$	4.4	-	-	V
		$I_{O} = -20 \mu A; V_{CC} = 6.0 V$	5.9	-	-	V
		$I_{O} = -6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.7	-	-	V
		$I_O = -7.8 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.2	-	-	V

 Table 6.
 Static characteristics 74HC373 ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{OL}$	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_O = 20 \mu A; V_{CC} = 2.0 \text{ V}$	-	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 4.5 V$	-	-	0.1	V
		$I_O = 20 \mu A; V_{CC} = 6.0 \text{ V}$	-	-	0.1	V
		$I_O = 6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.4	V
		$I_{O} = 7.8 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	-	0.4	V
I <sub>I</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 \text{ V}$	-	-	±1.0	μΑ
I <sub>OZ</sub>	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 6.0 \text{ V}$ ; $V_O = V_{CC}$ or GND	-	-	±10.0	μΑ
I <sub>CC</sub>	supply current	$V_{CC}$ = 6.0 V; $I_O$ = 0 A; $V_I$ = $V_{CC}$ or GND	-	-	160	μА

## Table 7. Static characteristics 74HCT373

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub> = 25	°C					
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	1.6	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	1.2	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_{O} = -20 \mu A; V_{CC} = 4.5 V$	4.4	4.5	-	V
		$I_{O} = -6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	4.32	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_O = 20 \mu A; V_{CC} = 4.5 V$	-	0.0	0.1	V
		$I_O = 6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.16	0.26	V
I <sub>I</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±0.1	μΑ
l <sub>OZ</sub>	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 5.5$ V; $V_O = V_{CC}$ or GND	-	-	±0.5	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	8.0	μА
Δl <sub>CC</sub>	additional supply current	$V_I = V_{CC} - 2.1 \text{ V};$ other inputs at $V_{CC}$ or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V; $I_O = 0 \text{ A}$				
		Dn	-	30	108	μΑ
		LE	-	150	540	μА
		ŌE	-	100	360	μΑ
Cı	input capacitance		-	3.5	-	pF
T <sub>amb</sub> = -4	0 °C to +85 °C					
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	-	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	$V_{I} = V_{IH}$ or $V_{IL}$				
		$I_{O} = -20 \mu A; V_{CC} = 4.5 V$	4.4	-	-	V
		$I_O = -6.0 \mu A; V_{CC} = 4.5 V$	3.84	-	-	V

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 Table 7.
 Static characteristics 74HCT373 ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>OL</sub>	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_O = 20 \mu A; V_{CC} = 4.5 V$	-	-	0.1	V
		$I_{O} = 6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.33	V
I <sub>I</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±1.0	μΑ
l <sub>OZ</sub>	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 5.5$ V; $V_O = V_{CC}$ or GND	-	-	±5.0	μΑ
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	80	μА
Δl <sub>CC</sub>	additional supply current	$V_I = V_{CC} - 2.1 \text{ V};$ other inputs at $V_{CC}$ or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V; $I_O = 0 \text{ A}$				
		Dn	-	-	135	μΑ
		LE	-	-	675	μΑ
		ŌĒ	-	-	450	μΑ
$T_{amb} = -4$	0 °C to +125 °C		·			
$V_{IH}$	HIGH-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	2.0	-	-	V
$V_{IL}$	LOW-level input voltage	V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	0.8	V
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_O = -20 \mu A$ ; $V_{CC} = 4.5 V$	4.4	-	-	V
		$I_{O} = -6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.7	-	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_O = 20 \mu A; V_{CC} = 4.5 V$	-	-	0.1	V
		$I_O = 6.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.4	V
I <sub>I</sub>	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 \text{ V}$	-	-	±1.0	μΑ
I <sub>OZ</sub>	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 5.5$ V; $V_O = V_{CC}$ or GND	-	-	±10	μА
I <sub>CC</sub>	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5 \text{ V}$	-	-	160	μΑ
Δl <sub>CC</sub>	additional supply current	$V_I = V_{CC} - 2.1 \text{ V};$ other inputs at $V_{CC}$ or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V; $I_O = 0 \text{ A}$				
		Dn	-	-	147	μΑ
		LE	-	-	735	μΑ
		ŌĒ	-	-	490	μΑ

# 10. Dynamic characteristics

Table 8. Dynamic characteristics 74HC373

Voltages are referenced to GND (ground = 0 V); C<sub>L</sub> = 50 pF unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub> = 2	5°C					
t <sub>pd</sub>	propagation delay	Dn to Qn; see Figure 8	[1]			
		V <sub>CC</sub> = 2.0 V	-	41	150	ns
		V <sub>CC</sub> = 4.5 V	-	15	30	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	12	-	ns
		V <sub>CC</sub> = 6.0 V	-	12	26	ns
		LE to Qn; see Figure 9				
		V <sub>CC</sub> = 2.0 V	-	50	175	ns
		V <sub>CC</sub> = 4.5 V	-	18	35	ns
		V <sub>CC</sub> = 5 V; C <sub>L</sub> = 15 pF	-	15	-	ns
		V <sub>CC</sub> = 6.0 V	-	14	30	ns
t <sub>en</sub>	enable time	OE to Qn; see Figure 10	[2]			
		V <sub>CC</sub> = 2.0 V	-	44	150	ns
		V <sub>CC</sub> = 4.5 V	-	16	30	ns
		V <sub>CC</sub> = 6.0 V	-	13	26	ns
t <sub>dis</sub>	disable time	OE to Qn; see Figure 10	[3]			
		V <sub>CC</sub> = 2.0 V	-	47	150	ns
		V <sub>CC</sub> = 4.5 V	-	17	30	ns
		V <sub>CC</sub> = 6.0 V	-	14	26	ns
t <sub>t</sub>	transition time	Qn; see Figure 8 and Figure 9	[4]			
		V <sub>CC</sub> = 2.0 V	-	14	60	ns
		V <sub>CC</sub> = 4.5 V	-	5	12	ns
		V <sub>CC</sub> = 6.0 V	-	4	10	ns
t <sub>W</sub>	pulse width	LE HIGH; see Figure 9				
		V <sub>CC</sub> = 2.0 V	80	17	-	ns
		V <sub>CC</sub> = 4.5 V	16	6	-	ns
		V <sub>CC</sub> = 6.0 V	14	5	-	ns
t <sub>su</sub>	set-up time	Dn to LE; see Figure 11				
		V <sub>CC</sub> = 2.0 V	50	14	-	ns
		V <sub>CC</sub> = 4.5 V	10	5	-	ns
		V <sub>CC</sub> = 6.0 V	9	4	-	ns
t <sub>h</sub>	hold time	Dn to LE; see Figure 11				
		V <sub>CC</sub> = 2.0 V	+5	-8	-	ns
		V <sub>CC</sub> = 4.5 V	+5	-3	-	ns
		V <sub>CC</sub> = 6.0 V	+5	-2	-	ns
C <sub>PD</sub>	power dissipation capacitance	per latch; $V_I = GND$ to $V_{CC}$	[5] _	45	-	pF

 Table 8.
 Dynamic characteristics 74HC373 ...continued

Voltages are referenced to GND (ground = 0 V);  $C_L = 50 \text{ pF}$  unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T <sub>amb</sub> = -	40 °C to +85 °C		1			
t <sub>pd</sub>	propagation delay	Dn to Qn; see Figure 8	[1]			
		V <sub>CC</sub> = 2.0 V	-	-	190	ns
		V <sub>CC</sub> = 4.5 V	-	-	38	ns
		V <sub>CC</sub> = 6.0 V	-	-	33	ns
		LE to Qn; see Figure 9				
		V <sub>CC</sub> = 2.0 V	-	-	220	ns
		V <sub>CC</sub> = 4.5 V	-	-	44	ns
		V <sub>CC</sub> = 6.0 V	-	-	37	ns
t <sub>en</sub>	enable time	OE to Qn; see Figure 10	[2]			
		V <sub>CC</sub> = 2.0 V	-	-	190	ns
		V <sub>CC</sub> = 4.5 V	-	-	38	ns
		V <sub>CC</sub> = 6.0 V	-	-	33	ns
t <sub>dis</sub>	disable time	OE to Qn; see Figure 10	[3]			
		V <sub>CC</sub> = 2.0 V	-	-	190	ns
		V <sub>CC</sub> = 4.5 V	-	-	38	ns
		V <sub>CC</sub> = 6.0 V	-	-	33	ns
t <sub>t</sub>	transition time	Qn; see Figure 8 and Figure 9	[4]			
		V <sub>CC</sub> = 2.0 V	-	-	75	ns
		V <sub>CC</sub> = 4.5 V	-	-	15	ns
		V <sub>CC</sub> = 6.0 V	-	-	13	ns
t <sub>W</sub>	pulse width	LE HIGH; see Figure 9				
		V <sub>CC</sub> = 2.0 V	100	-	-	ns
		V <sub>CC</sub> = 4.5 V	20	-	-	ns
		V <sub>CC</sub> = 6.0 V	17	-	-	ns
t <sub>su</sub>	set-up time	Dn to LE; see Figure 11				
		V <sub>CC</sub> = 2.0 V	65	-	-	ns
		V <sub>CC</sub> = 4.5 V	13	-	-	ns
		V <sub>CC</sub> = 6.0 V	11	-	-	ns
t <sub>h</sub>	hold time	Dn to LE; see Figure 11				
		V <sub>CC</sub> = 2.0 V	5	-	-	ns
		V <sub>CC</sub> = 4.5 V	5	-	-	ns
		V <sub>CC</sub> = 6.0 V	5	-	-	ns

 Table 8.
 Dynamic characteristics 74HC373 ...continued

Voltages are referenced to GND (ground = 0 V);  $C_L = 50 \text{ pF}$  unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
T <sub>amb</sub> = -	40 °C to +125 °C	1	l				
t <sub>pd</sub>	propagation delay	Dn to Qn; see Figure 8	<u>[1]</u>				
		V <sub>CC</sub> = 2.0 V		-	-	225	ns
		V <sub>CC</sub> = 4.5 V		-	-	45	ns
		V <sub>CC</sub> = 6.0 V		-	-	38	ns
		LE to Qn; see Figure 9					
		V <sub>CC</sub> = 2.0 V		-	-	265	ns
		V <sub>CC</sub> = 4.5 V		-	-	53	ns
		V <sub>CC</sub> = 6.0 V		-	-	45	ns
t <sub>en</sub>	enable time	OE to Qn; see Figure 10	[2]				
		V <sub>CC</sub> = 2.0 V		-	-	225	ns
		V <sub>CC</sub> = 4.5 V		-	-	45	ns
		V <sub>CC</sub> = 6.0 V		-	-	38	ns
t <sub>dis</sub>	disable time	OE to Qn; see Figure 10	[3]				
		V <sub>CC</sub> = 2.0 V		-	-	225	ns
		V <sub>CC</sub> = 4.5 V		-	-	45	ns
		V <sub>CC</sub> = 6.0 V		-	-	38	ns
t <sub>t</sub>	transition time	Qn; see Figure 8 and Figure 9	[4]				
		V <sub>CC</sub> = 2.0 V		-	-	90	ns
		V <sub>CC</sub> = 4.5 V		-	-	18	ns
		V <sub>CC</sub> = 6.0 V		-	-	15	ns
tw	pulse width	LE HIGH; see Figure 9					
		V <sub>CC</sub> = 2.0 V		120	-	-	ns
		V <sub>CC</sub> = 4.5 V		24	-	-	ns
		V <sub>CC</sub> = 6.0 V		20	-	-	ns
t <sub>su</sub>	set-up time	Dn to LE; see Figure 11					
		V <sub>CC</sub> = 2.0 V		75	-	-	ns
		V <sub>CC</sub> = 4.5 V		15	-	-	ns
		V <sub>CC</sub> = 6.0 V		13	-	-	ns

 Table 8.
 Dynamic characteristics 74HC373 ...continued

Voltages are referenced to GND (ground = 0 V);  $C_L = 50 \text{ pF}$  unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t <sub>h</sub>	hold time	Dn to LE; see Figure 11				
		V <sub>CC</sub> = 2.0 V	5	-	-	ns
		V <sub>CC</sub> = 4.5 V	5	-	-	ns
		V <sub>CC</sub> = 6.0 V	5	-	-	ns

- [1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .
- [2]  $t_{en}$  is the same as  $t_{PZH}$  and  $t_{PZL}$ .
- [3]  $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ .
- [4]  $t_t$  is the same as  $t_{THL}$  and  $t_{TLH}$ .
- [5]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$  where:

f<sub>i</sub> = input frequency in MHz;

fo = output frequency in MHz;

 $C_L$  = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}{}^2 \times f_o)$  = sum of outputs.

### Table 9. Dynamic characteristics 74HCT373

Voltages are referenced to GND (ground = 0 V); C<sub>L</sub> = 50 pF unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
T <sub>amb</sub> = 2	5 °C		'				
t <sub>pd</sub>	propagation delay	Dn to Qn; see Figure 8					
		V <sub>CC</sub> = 4.5 V		-	17	30	ns
		$V_{CC} = 5 \text{ V}; C_L = 15 \text{ pF}$		-	14	-	ns
		LE to Qn; see Figure 9					
		V <sub>CC</sub> = 4.5 V		-	16	32	ns
		$V_{CC} = 5 \text{ V}; C_L = 15 \text{ pF}$		-	13	-	ns
t <sub>en</sub>	enable time	OE to Qn; see Figure 10	[2]				
		V <sub>CC</sub> = 4.5 V		-	19	32	ns
t <sub>dis</sub> disable time		OE to Qn; see Figure 10	[3]				
		V <sub>CC</sub> = 4.5 V		-	18	30	ns
t <sub>t</sub>	transition time	Qn; see Figure 8 and Figure 9	<u>[4]</u>				
		V <sub>CC</sub> = 4.5 V		-	5	12	ns
t <sub>W</sub>	pulse width	LE HIGH; see Figure 9					
		V <sub>CC</sub> = 4.5 V		16	4	-	ns
t <sub>su</sub>	set-up time	Dn to LE; see Figure 11					
		V <sub>CC</sub> = 4.5 V		12	6	-	ns
t <sub>h</sub>	hold time	Dn to LE; see Figure 11					
		V <sub>CC</sub> = 4.5 V		4	-1	-	ns
C <sub>PD</sub>	power dissipation capacitance	per latch; V <sub>I</sub> = GND to (V <sub>CC</sub> – 1.5 V)	<u>[5]</u>	-	41	-	pF

 Table 9.
 Dynamic characteristics 74HCT373 ...continued

Voltages are referenced to GND (ground = 0 V);  $C_L = 50 \text{ pF}$  unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
T <sub>amb</sub> = -	40 °C to +85 °C	,					
t <sub>pd</sub>	propagation delay	Dn to Qn; see Figure 8	<u>[1]</u>				
		V <sub>CC</sub> = 4.5 V		-	-	38	ns
		LE to Qn; see Figure 9					
		V <sub>CC</sub> = 4.5 V		-	-	40	ns
t <sub>en</sub>	enable time	OE to Qn; see Figure 10	[2]				
		V <sub>CC</sub> = 4.5 V		-	-	40	ns
t <sub>dis</sub>	disable time	OE to Qn; see Figure 10	[3]				
		V <sub>CC</sub> = 4.5 V		-	-	38	ns
t <sub>t</sub>	transition time	Qn; see Figure 8 and Figure 9	<u>[4]</u>				
		V <sub>CC</sub> = 4.5 V		-	-	15	ns
t <sub>W</sub>	pulse width	LE HIGH; see Figure 9					
		V <sub>CC</sub> = 4.5 V		20	-	-	ns
t <sub>su</sub>	set-up time	Dn to LE; see Figure 11					
		V <sub>CC</sub> = 4.5 V		15	-	-	ns
t <sub>h</sub>	hold time	Dn to LE; see Figure 11					
		V <sub>CC</sub> = 4.5 V		4	-	-	ns
T <sub>amb</sub> = -	40 °C to +125 °C	,	'				
t <sub>pd</sub>	propagation delay	Dn to Qn; see Figure 8	<u>[1]</u>				
		V <sub>CC</sub> = 4.5 V		-	-	45	ns
		LE to Qn; see Figure 9					
		V <sub>CC</sub> = 4.5 V		-	-	48	ns
t <sub>en</sub>	enable time	OE to Qn; see Figure 10	[2]				
		V <sub>CC</sub> = 4.5 V		-	-	48	ns
t <sub>dis</sub>	disable time	OE to Qn; see Figure 10	[3]				
		V <sub>CC</sub> = 4.5 V		-	-	45	ns
t <sub>t</sub>	transition time	Qn; see Figure 8 and Figure 9	[4]				
		V <sub>CC</sub> = 4.5 V		-	-	18	ns
t <sub>W</sub>	pulse width	LE HIGH; see Figure 9					
		V <sub>CC</sub> = 4.5 V		24	-	-	ns
t <sub>su</sub>	set-up time	Dn to LE; see Figure 11					
		V <sub>CC</sub> = 4.5 V		18	-	-	ns

 Table 9.
 Dynamic characteristics 74HCT373 ...continued

Voltages are referenced to GND (ground = 0 V);  $C_L = 50 \ pF$  unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t <sub>h</sub>	hold time	Dn to LE; see Figure 11				
		V <sub>CC</sub> = 4.5 V	4	-	-	ns

- [1]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .
- [2]  $t_{en}$  is the same as  $t_{PZH}$  and  $t_{PZL}$ .
- [3]  $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ .
- [4]  $t_t$  is the same as  $t_{THL}$  and  $t_{TLH}$ .
- [5]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz;

f<sub>o</sub> = output frequency in MHz;

C<sub>I</sub> = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$ 

# 11. Waveforms

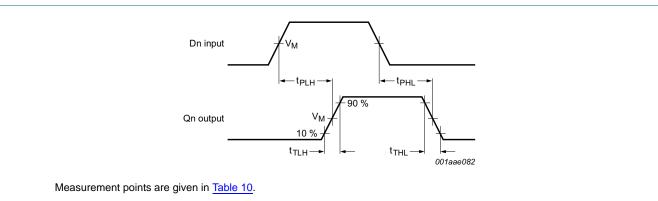


Fig 8. Propagation delay input (Dn) to output (Qn) and transition time output (Qn)

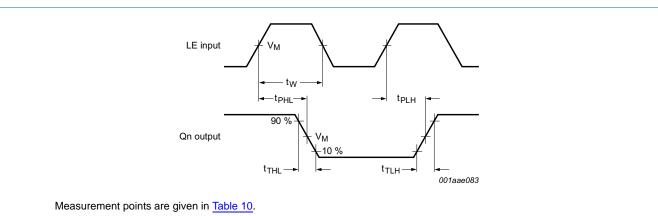
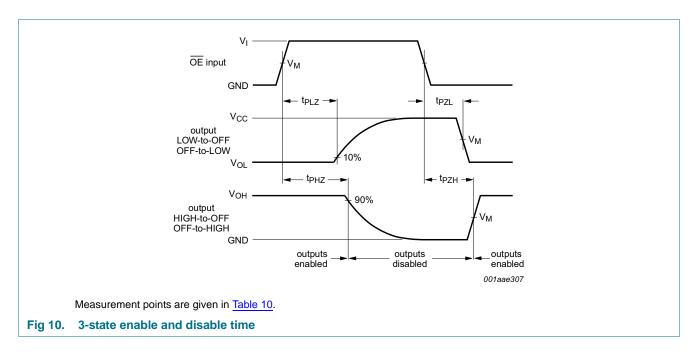


Fig 9. Pulse width latch enable input (LE), propagation delay (LE) to output (Qn) and transition time output (Qn)

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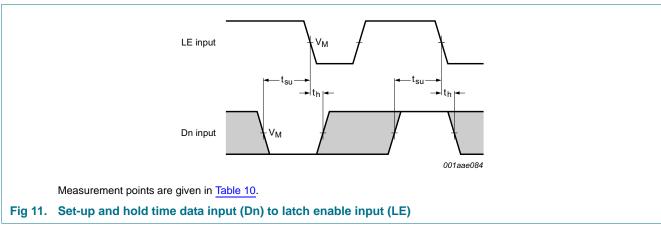
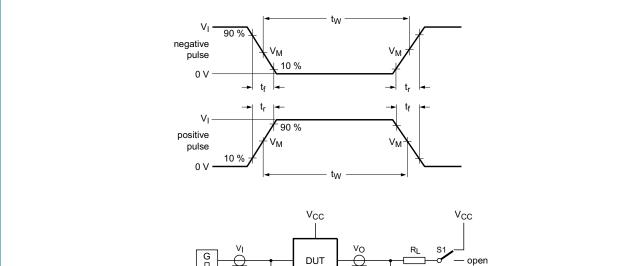


Table 10. Measurement points

Туре	Input	Output
	V <sub>M</sub>	V <sub>M</sub>
74HC373	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>
74HCT373	1.3 V	1.3 V

001aad983

Octal D-type transparent latch; 3-state



Test data is given in Table 11.

Definitions test circuit:

 $R_T$  = Termination resistance should be equal to output impedance  $Z_0$  of the pulse generator

 $C_L$  = Load capacitance including jig and probe capacitance

R<sub>L</sub> = Load resistor

S1 = Test selection switch

Fig 12. Test circuit for measuring switching times

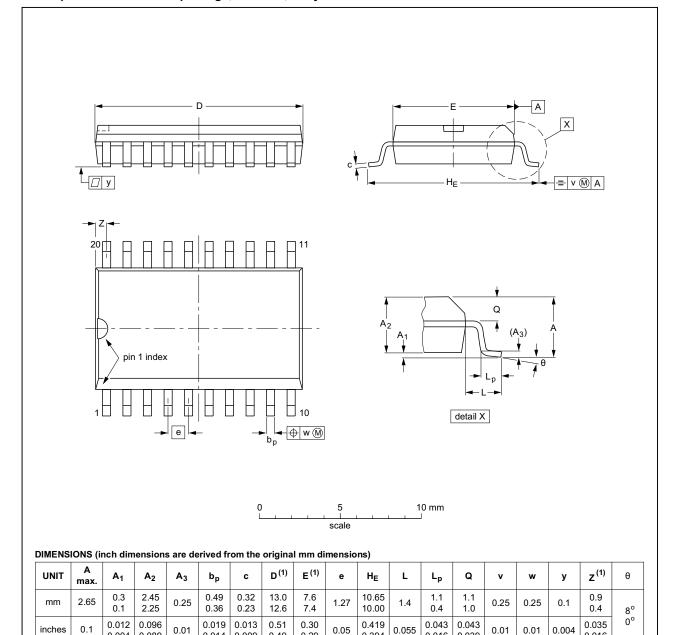
Table 11. Test data

Туре	Input		Load		S1 position				
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	R <sub>L</sub>	t <sub>PHL</sub> , t <sub>PLH</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>		
74HC373	V <sub>CC</sub>	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V <sub>CC</sub>		
74HCT373	3 V 6 ns		15 pF, 50 pF		open	n GND			

# 12. Package outline

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



#### Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

0.014

0.009

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC JEDEC		JEITA		PROJECTION	ISSUE DATE
SOT163-1	075E04	MS-013				<del>99-12-27</del> 03-02-19

0.394

0.016

0.039

Fig 13. Package outline SOT163-1 (SO20)

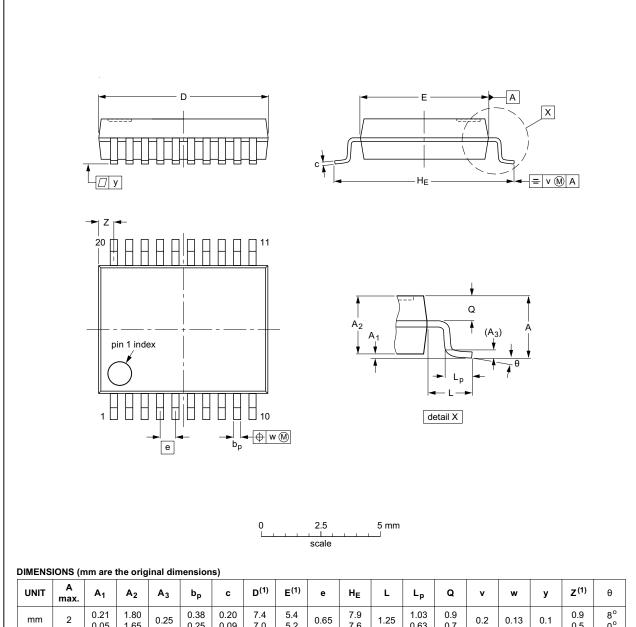
0.004

0.089

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# SSOP20: plastic shrink small outline package; 20 leads; body width 5.3 mm

SOT339-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	<b>A</b> <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(1)</sup>	е	HE	L	Lp	ø	v	¥	у	Z <sup>(1)</sup>	θ
mm	2	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	7.4 7.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	0.9 0.5	8° 0°

### Note

1. Plastic or metal protrusions of 0.2 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	IEC JEDEC JI			PROJECTION	ISSUE DATE
SOT339-1		MO-150				<del>99-12-27</del> 03-02-19

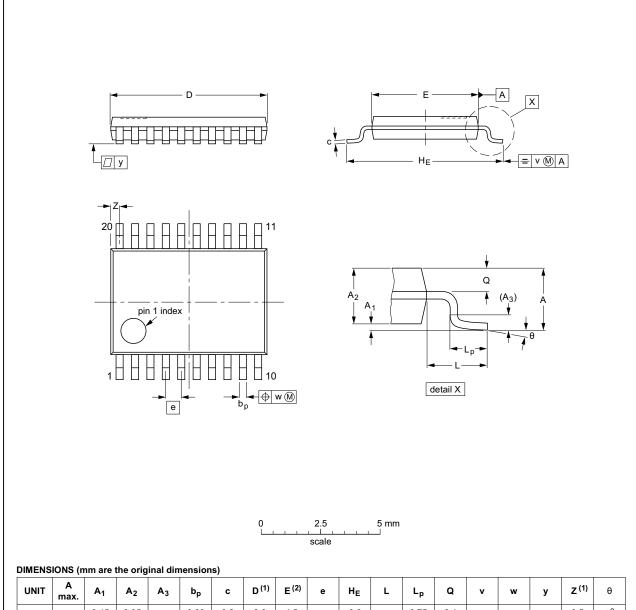
Fig 14. Package outline SOT339-1 (SSOP20)

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TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	<b>A</b> <sub>3</sub>	bp	С	D <sup>(1)</sup>	E (2)	е	HE	L	Lp	Q	v	w	у	Z <sup>(1)</sup>	θ
mm	1.1	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	6.6 6.4	4.5 4.3	0.65	6.6 6.2	1	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.5 0.2	8° 0°

### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

		REFERENCES			
IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
	MO-153				<del>99-12-27</del> 03-02-19
_	IEC				IEC JEDEC JEHA

Fig 15. Package outline SOT360-1 (TSSOP20)

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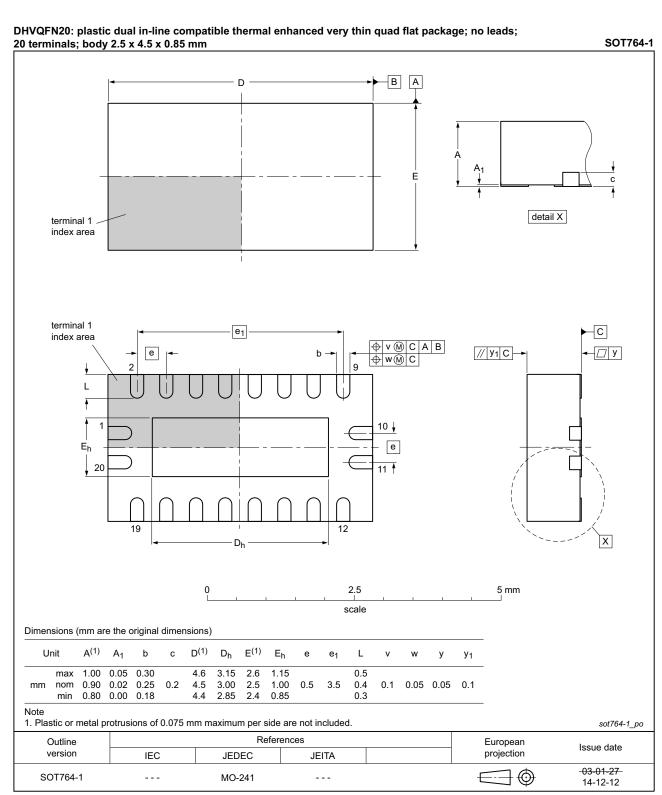


Fig 16. Package outline SOT764-1 (DHVQFN20)

# 13. Abbreviations

## Table 12. Abbreviations

Acronym	Description
CMOS	Complementary Metal Oxide Semiconductor
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

# 14. Revision history

## Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT373 v.6	20160226	Product data sheet	-	74HC_HCT373 v.5
Modifications:	Type numbers 74HC373N and 74HCT373N (SOT146-1) removed.			
74HC_HCT373 v.5	20111213	Product data sheet	-	74HC_HCT373 v.4
Modifications:	Legal pages updated.			
74HC_HCT373 v.4	20100903	Product data sheet	-	74HC_HCT373 v.3
74HC_HCT373 v.3	20060120	Product data sheet	-	74HC_HCT373_CNV v.2
74HC_HCT373_CNV v.2	19970827	Product specification	-	-

# 15. Legal information

### 15.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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# 74HC373; 74HCT373

### Octal D-type transparent latch; 3-state

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